

# BD241BFP BD242BFP

## COMPLEMENTARY SILICON POWER TRANSISTORS

- SGS-THOMSON PREFERRED SALESTYPES
- COMPLEMENTARY PNP NPN DEVICES
- FULLY MOLDED ISOLATED PACKAGE
- 2000 V DC ISOLATION (U.L. COMPLIANT)

#### **APPLICATIONS**

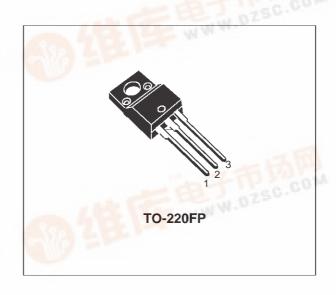
- GENERAL PURPOSE SWITCHING
- GENERAL PURPOSE AMPLIFIERS

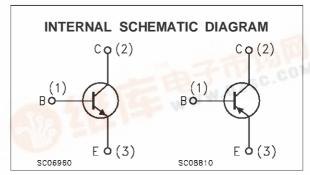
#### **DESCRIPTION**

The BD241BFP is silicon epitaxial-base NPN transistors mounted in TO-220FP fully molded isolated package.

It is inteded for power linear and switching applications.

The complementary PNP types is the BD242BFP.





#### ABSOLUTE MAXIMUM RATINGS

| Symbol           | Parameter  |     | Value      | Unit |
|------------------|--|-----|------------|------|
|                  |  | NPN | BD241BFP   | 72   |
|                  |  | PNP | BD242BFP   | 0.0. |
| V <sub>CER</sub> | Collector-Base Voltage ( $R_{BE} = 100 \Omega$ ) |     | 90         | V    |
| V <sub>CEO</sub> | Collector-Emitter Voltage (I <sub>B</sub> = 0)   |     | 80         | V    |
| V <sub>EBO</sub> | Emitter-Base Voltage (I <sub>C</sub> = 0)        |     | 5          | V    |
| Ic               | Collector Current                                |     | 3          | А    |
| I <sub>CM</sub>  | Collector Peak Current                           |     | 5          | А    |
| I <sub>B</sub>   | Base Current                                     |     | 1          | А    |
| Ptot             | Total Dissipation at T <sub>c</sub> ≤ 25 °C      |     | 24         | W    |
| T <sub>stg</sub> | Storage Temperature                              |     | -65 to 150 | °C   |
| Tj               | Max. Operating Junction Temperature              |     | 150        | °C   |

For PNP types voltage and current values are negative.



#### BD241BFP/BD242BFP

#### THERMAL DATA

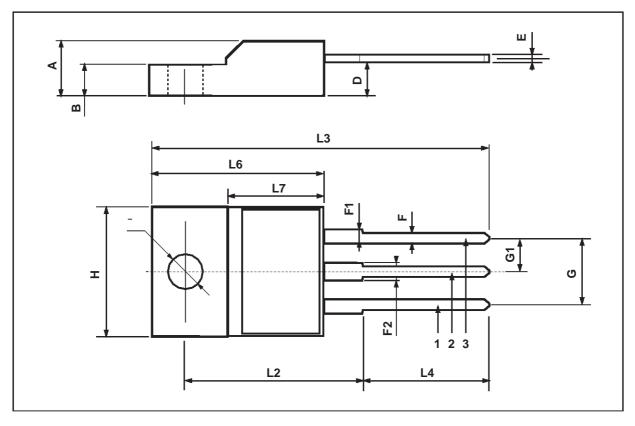
## **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

| Symbol                 | Parameter   | Test Conditions                             | Min.     | Тур. | Max. | Unit |
|------------------------|---|---|----------|------|------|------|
| I <sub>CEO</sub>       | Collector Cut-off<br>Current (I <sub>B</sub> = 0)               | V <sub>CE</sub> = 60 V                      |          |      | 0.3  | mA   |
| I <sub>CES</sub>       | Collector Cut-off<br>Current (V <sub>BE</sub> = 0)              | V <sub>CE</sub> = 80 V                      |          |      | 0.2  | mA   |
| I <sub>EBO</sub>       | Emitter Cut-off Current (I <sub>C</sub> = 0)                    | V <sub>EB</sub> = 5 V                       |          |      | 1    | mA   |
| V <sub>CEO(sus)*</sub> | Collector-Emitter<br>Sustaining Voltage<br>(I <sub>B</sub> = 0) | I <sub>C</sub> = 30 mA                      | 80       |      |      | V    |
| V <sub>CE(sat)</sub> * | Collector-Emitter<br>Saturation Voltage                         | I <sub>C</sub> = 3 A I <sub>B</sub> = 0.6 A |          |      | 1.2  | V    |
| V <sub>BE(ON)</sub> *  | Base-Emitter Voltage  | I <sub>C</sub> = 3 A V <sub>CE</sub> = 4 V  |          |      | 1.8  | V    |
| h <sub>FE</sub> ∗      | DC Current Gain   | I <sub>C</sub> = 1 A                        | 25<br>10 |      |      |      |

<sup>\*</sup> Pulsed: Pulse duration =  $300 \,\mu s$ , duty cycle  $\leq 2 \,\%$ For PNP types voltage and current values are negative.

### **TO-220FP MECHANICAL DATA**

| DIM. | mm   |      |      | inch  |       |       |  |
|------|------|------|------|-------|-------|-------|--|
| DIN. | MIN. | TYP. | MAX. | MIN.  | TYP.  | MAX.  |  |
| А    | 4.4  |      | 4.6  | 0.173 |       | 0.181 |  |
| В    | 2.5  |      | 2.7  | 0.098 |       | 0.106 |  |
| D    | 2.5  |      | 2.75 | 0.098 |       | 0.108 |  |
| E    | 0.45 |      | 0.7  | 0.017 |       | 0.027 |  |
| F    | 0.75 |      | 1    | 0.030 |       | 0.039 |  |
| F1   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |  |
| F2   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |  |
| G    | 4.95 |      | 5.2  | 0.195 |       | 0.204 |  |
| G1   | 2.4  |      | 2.7  | 0.094 |       | 0.106 |  |
| Н    | 10   |      | 10.4 | 0.393 |       | 0.409 |  |
| L2   |      | 16   |      |       | 0.630 |       |  |
| L3   | 28.6 |      | 30.6 | 1.126 |       | 1.204 |  |
| L4   | 9.8  |      | 10.6 | 0.385 |       | 0.417 |  |
| L6   | 15.9 |      | 16.4 | 0.626 |       | 0.645 |  |
| L7   | 9    |      | 9.3  | 0.354 |       | 0.366 |  |
| Ø    | 3    |      | 3.2  | 0.118 |       | 0.126 |  |



#### BD241BFP/BD242BFP

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